

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT7090683

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
JUN HEE JUNG	12/22/2021
JAE IL HWANG	12/22/2021
BON SEOK KU	12/22/2021
JEONG HWAN LEE	12/22/2021
SEI HOON CHO	12/22/2021
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SK INNOVATION CO., LTD.
<b>Street Address:</b>	26, JONG-RO, JONGNO-GU
<b>City:</b>	SEOUL
<b>State/Country:</b>	KOREA, REPUBLIC OF
<b>Postal Code:</b>	03188
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	17560536
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(412)471-4094
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	4124718815
<b>Email:</b>	assignments@webblaw.com
<b>Correspondent Name:</b>	THE WEBB LAW FIRM, P.C.
<b>Address Line 1:</b>	ONE GATEWAY CENTER
<b>Address Line 2:</b>	420 FT. DUQUESNE BLVD., SUITE 1200
<b>Address Line 4:</b>	PITTSBURGH, PENNSYLVANIA 15222
<b>ATTORNEY DOCKET NUMBER:</b>	5038-2108237
<b>NAME OF SUBMITTER:</b>	RICHARD L. BYRNE REG.#28498
<b>SIGNATURE:</b>	/Richard L. Byrne/
<b>DATE SIGNED:</b>	12/23/2021
<b>Total Attachments: 3</b>	

source=Assignment#page1.tif

source=Assignment#page2.tif

source=Assignment#page3.tif

ASSIGNMENT

WHEREAS, as a below named inventor, I have invented certain new and useful improvements in

POUCH TYPE BATTERY CELL AND BATTERY PACK INCLUDING THE SAME  
(Invention Title)

for which I have this day executed an application for a United States Patent (hereinafter "said application").

AND/OR

for which an application for a United States Patent was filed on \_\_\_\_\_ (mm/dd/yyyy) and bears Application Number \_\_\_\_\_ (hereinafter "said application").

AND/OR

for which an international patent application was filed under the Patent Cooperation Treaty on \_\_\_\_\_ (mm/dd/yyyy), bearing Application No. \_\_\_\_\_ (hereinafter "said application").

AND, WHEREAS, SK Innovation Co., Ltd., a corporation of the Republic of Korea, having a place of business at 26, Jong-ro, Jongno-gu, Seoul 03188, Republic of Korea, hereinafter called the "assignee", is desirous of acquiring the entire right, title, and interest in and to said application and the inventions and improvements therein disclosed.

NOW, THEREFORE, for good and valuable consideration paid to me by said assignee, the receipt of which is hereby acknowledged, I as the inventor or as one of the inventors, hereinafter the assignor(s), do hereby assign, sell and transfer unto said assignee the full and exclusive right, title and interest in and to said application and the inventions and improvements therein disclosed for the United States and all foreign countries, including rights of priority under the International Convention of Paris (1883) as amended, and any Letters Patent which may issue therefor in the United States and all foreign countries and all divisions, reissues, continuations, continuations-in-part, renewals and/or extensions thereof. Such assignment extends to the full ends of the terms of these applications and patents as fully and entirely as the same would have been held and enjoyed by me had this Assignment not been made.

I hereby authorize and request any attorney associated with The Webb Law Firm, Customer No. 28289, to insert here in parentheses (Application No. 17/560,536, filed 12/23/2021) the filing date and application number of said application when known.

I covenant that I am the lawful owner(s) of said application, inventions and improvements, that the same are unencumbered, that no license has been granted to make, use or vend the said inventions or improvements or any of them, and that I have the full right to make this Assignment.

INTERNATIONAL

Application No. \_\_\_\_\_

Attorney Docket No. 5038-2108237

And for the consideration aforesaid, I agree individually and, if applicable, jointly that I will communicate to said assignee or the representatives thereof any facts known to me respecting said inventions and improvements, and will, upon request but without expense to me, testify in any legal proceedings, sign all lawful papers, execute all divisional, reissue, continuation, continuation-in-part, renewal and/or extension applications, make all rightful oaths, and generally do all other and further lawful acts deemed necessary or expedient by said assignee or by counsel for said assignee to assist or enable said assignee to obtain and enforce full benefits from the rights and interests herein assigned. This Assignment shall be binding upon my heirs, executors, administrators and/or assigns, and shall inure to the benefit of the heirs, executors, administrators, successors and/or assigns, as the case may be, of said assignee.

1. FULL NAME OF ASSIGNOR:

Jun Hee Jung

RESIDENCE:

Daejeon, Republic of Korea

EXECUTED this 22 day of Dec, 2021



SIGNATURE

WITNESS:

.....

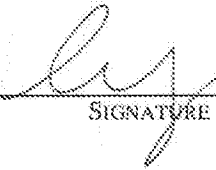
2. FULL NAME OF ASSIGNOR:

Jae Il Hwang

RESIDENCE:

Daejeon, Republic of Korea

EXECUTED this 22 day of Dec, 2021



SIGNATURE

WITNESS:

.....

Checked Box indicates 1 additional page for inventor signatures.

INTERNATIONAL

Application No. \_\_\_\_\_

Attorney Docket No. 5038-2108237

3. FULL NAME OF ASSIGNOR:  
Bon Seok Ku

RESIDENCE:  
Daejeon, Republic of Korea

EXECUTED this 22 day of Dec, 2021


  
SIGNATURE

WITNESS:  
\_\_\_\_\_

4. FULL NAME OF ASSIGNOR:  
Jeong Hwan Lee

RESIDENCE:  
Daejeon, Republic of Korea

EXECUTED this 22 day of Dec., 2021

  
SIGNATURE

WITNESS:  
\_\_\_\_\_

5. FULL NAME OF ASSIGNOR:  
Sei Hoon Cho

RESIDENCE:  
Daejeon, Republic of Korea

EXECUTED this 22 day of 12, 2021

  
SIGNATURE

WITNESS:  
\_\_\_\_\_